

BFG92A/X

NPN 5 GHz wideband transistor

Rev. 06 — 12 March 2008

Product data sheet

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NXP Semiconductors



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FEATURES

- High power gain
- Low noise figure
- Gold metallization ensures excellent reliability.

APPLICATIONS

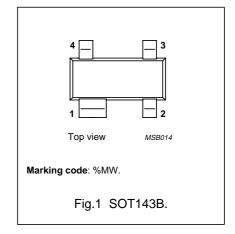
Wideband applications in the UHF and microwave range.

DESCRIPTION

Silicon NPN transistor in a 4-pin, dual-emitter SOT143B plastic package.

PINNING

PIN	DESCRIPTION					
1	collector					
2	emitter					
3	base					
4	emitter					



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage		_	_	20	V
V _{CEO}	collector-emitter voltage		_	_	15	V
I _C	collector current (DC)		_	_	25	mA
P _{tot}	total power dissipation	T _s ≤ 60 °C	_	_	400	mW
C _{re}	feedback capacitance	$I_C = i_c = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	_	0.35	_	pF
f _T	transition frequency	I _C = 15 mA; V _{CE} = 10 V; f = 500 MHz	3.5	5	_	GHz
G _{UM}	maximum unilateral power gain	I_C = 15 mA; V_{CE} = 10 V; T_{amb} = 25 °C; f = 1 GHz	_	16	_	dB
		I_{C} = 15 mA; V_{CE} = 10 V; T_{amb} = 25 °C; f = 2 GHz	_	11	_	dB
F	noise figure	$\Gamma_{\rm S} = \Gamma_{\rm opt}; \ I_{\rm C} = 5 \ \text{mA}; \ V_{\rm CE} = 10 \ \text{V}; \ T_{\rm amb} = 25 \ ^{\circ}\text{C}; \ f = 1 \ \text{GHz}$	_	2	_	dB

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CEO}	collector-emitter voltage	open base	_	15	V
V _{EBO}	emitter-base voltage	open collector	_	2	V
I _C	collector current (DC)		_	25	mA
P _{tot}	total power dissipation	T _s ≤ 60 °C; note 1	_	400	mW
T _{stg}	storage temperature range		-65	150	°C
Tj	junction temperature		_	175	°C

Note

1. T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	note 1	290	K/W

Note

1. T_s is the temperature at the soldering point of the collector pin.

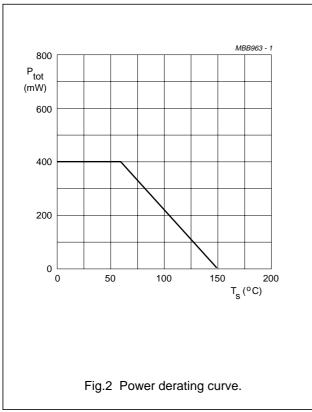
CHARACTERISTICS

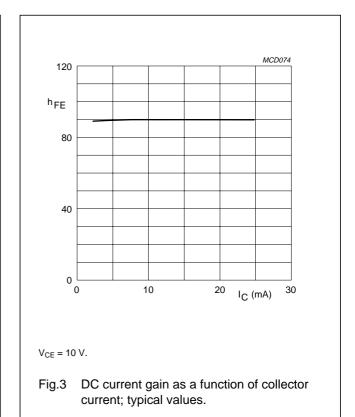
 $T_i = 25$ °C unless otherwise specified.

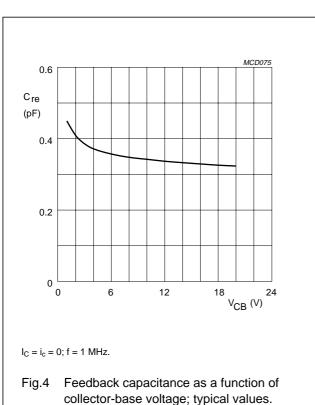
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector leakage current	I _E = 0; V _{CB} = 10 V	_	_	50	nA
h _{FE}	DC current gain	I _C = 15 mA; V _{CE} = 10 V	65	90	135	
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	_	0.6	_	pF
Ce	emitter capacitance	$I_C = i_C = 0$; $V_{EB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	_	0.9	_	pF
C _{re}	feedback capacitance	$I_C = I_c = 0$; $V_{CB} = 10 \text{ V}$; $f = 1 \text{ MHz}$	_	0.35	_	pF
f _T	transition frequency	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}$	3.5	5	_	GHz
G _{UM}	maximum unilateral power gain; note 1	$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 1 \text{ GHz}$	_	16	_	dB
		$I_C = 15 \text{ mA}; V_{CE} = 10 \text{ V};$ $T_{amb} = 25 ^{\circ}\text{C}; f = 2 \text{ GHz}$	_	11	_	dB
F	noise figure	$\Gamma_{\rm s}$ = $\Gamma_{\rm opt}$; $I_{\rm C}$ = 5 mA; $V_{\rm CE}$ = 10 V; $T_{\rm amb}$ = 25 °C; f = 1 GHz	_	2	_	dB
		$\Gamma_{\rm s}$ = $\Gamma_{\rm opt}$; I _C = 5 mA; V _{CE} = 10 V; $T_{\rm amb}$ = 25 °C; f = 2 GHz	_	3	_	dB

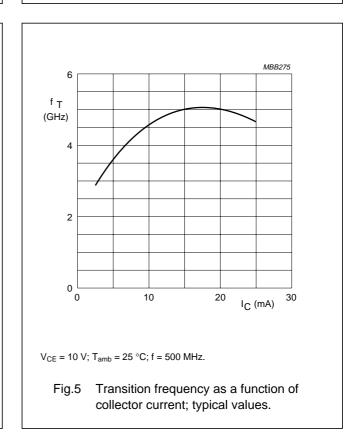
Note

 $\text{1.} \quad G_{UM} \text{ is the maximum unilateral power gain, assuming } S_{12} \text{ is zero and } G_{UM} = 10 \ \log \frac{\left|S_{21}\right|^2}{(1-\left|S_{11}\right|^2) \ (1-\left|S_{22}\right|^2)} \ dB.$









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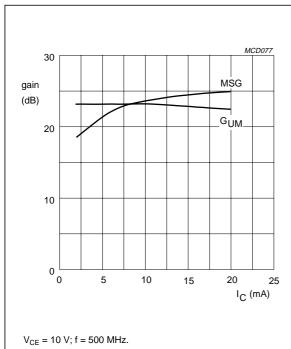
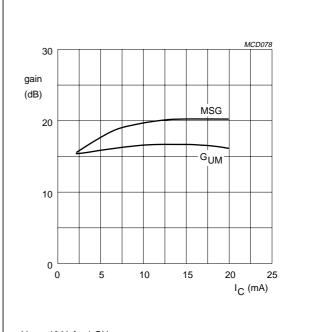


Fig.6 Gain as a function of collector current; typical values.



 $V_{CE} = 10 \text{ V}$; f = 1 GHz.

Fig.7 Gain as a function of collector current; typical values.

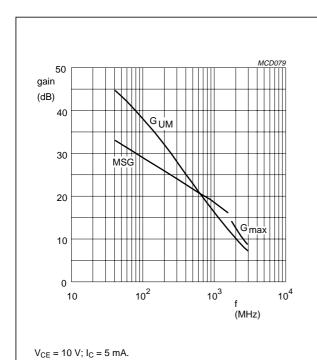
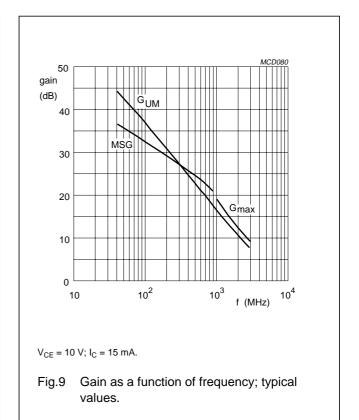
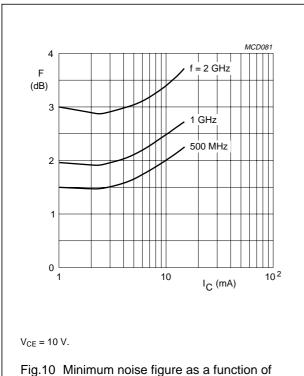


Fig.8 Gain as a function of frequency; typical values.



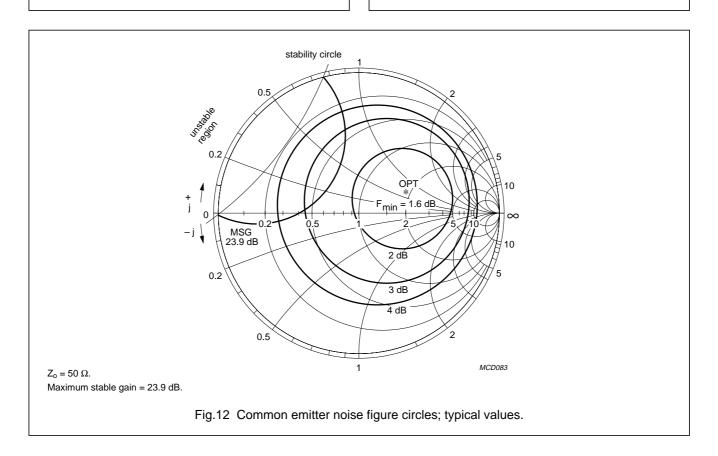
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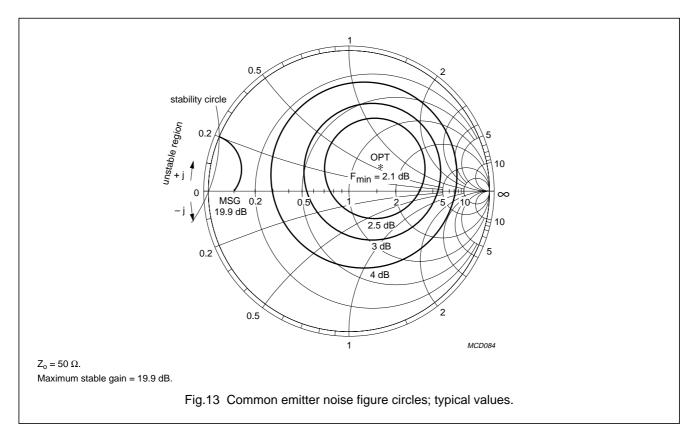


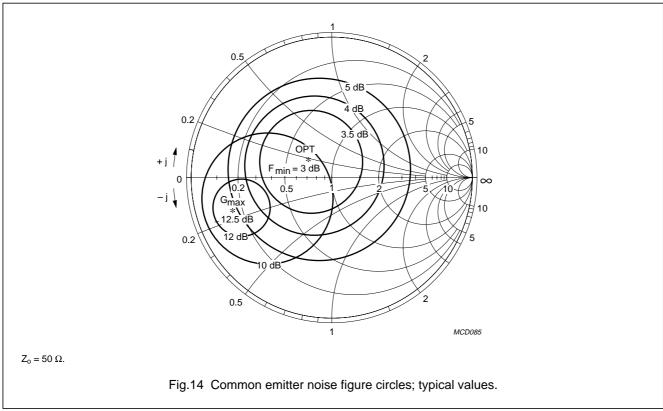
 $V_{CE} = 10 \text{ V}.$ Fig.11 Minimum noise figure as a function of frequency; typical values.

Fig.10 Minimum noise figure as a function of collector current; typical values.

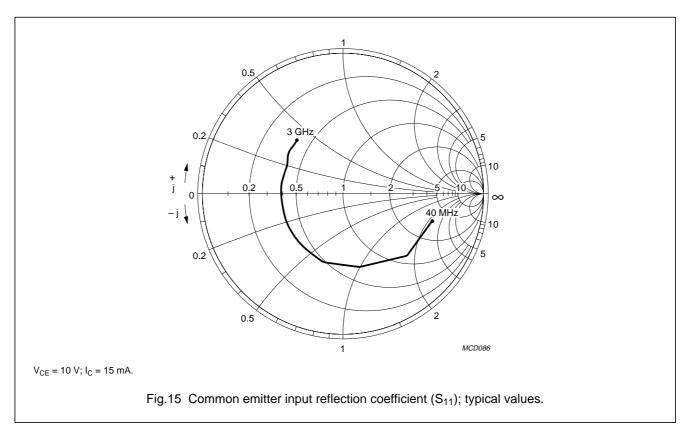


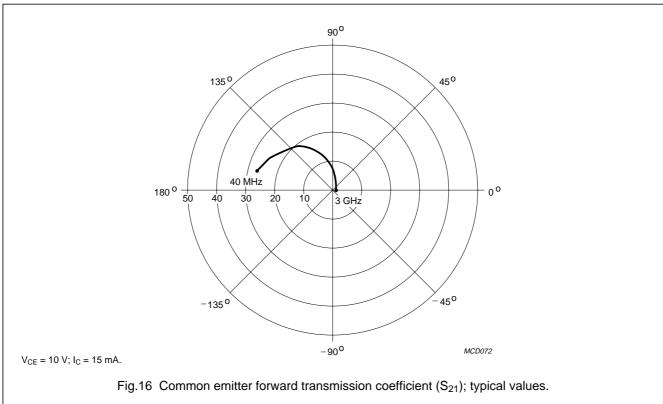
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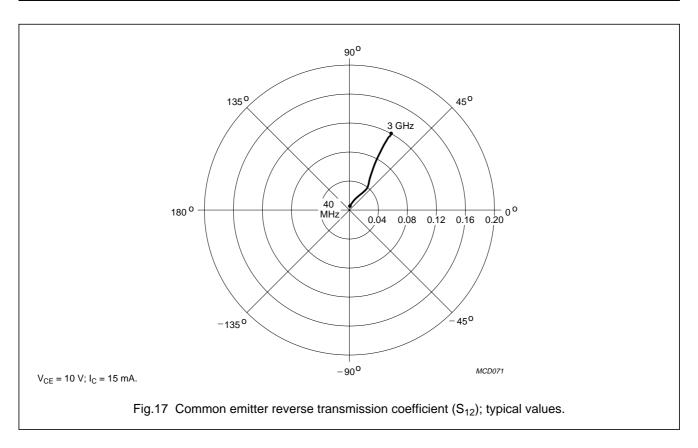


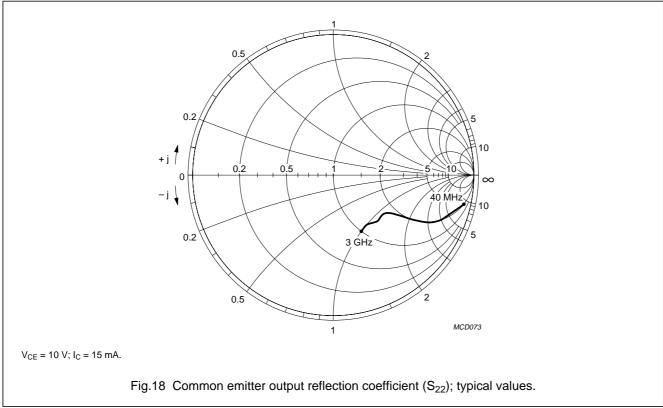
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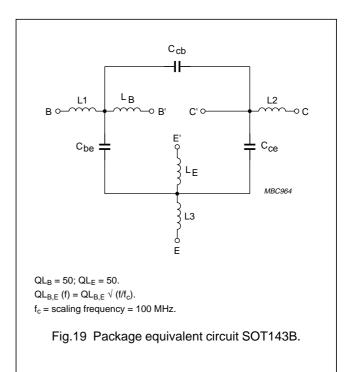
SPICE parameters for BFR90A/X die

SEQUENCE No.	PARAMETER	VALUE	UNIT
1	IS	411.8	аА
2	BF	102.6	_
3	NF	997.2	m
4	VAF	62.67	V
5	IKF	3.200	Α
6	ISE	4.010	fA
7	NE	1.577	_
8	BR	18.10	_
9	NR	996.2	m
10	VAR	3.369	V
11	IKR	1.281	Α
12	ISC	279.9	аА
13	NC	1.075	_
14	RB	10.00	Ω
15	IRB	1.000	μΑ
16	RBM	10.00	Ω
17	RE	1.164	Ω
18	RC	2.320	Ω
19 (note 1)	XTB	0.000	_
20 (note 1)	EG	1.110	eV
21 (note 1)	XTI	3.000	_
22	CJE	890.5	fF
23	VJE	600.0	mV
24	MJE	258.5	m
25	TF	15.49	ps
26	XTF	39.14	_
27	VTF	2.152	V
28	ITF	213.7	mA
29	PTF	0.000	deg
30	CJC	546.5	fF
31	VJC	380.8	mV
32	MJC	202.9	m
33	XCJC	150.0	m
34	TR	5.618	ns
35 (note 1)	CJS	0.000	F

SEQUENCE No.	PARAMETER	VALUE	UNIT
36 (note 1)	VJS	750.0	mV
37 (note 1)	MJS	0.000	_
38	FC	850.0	m

Note

1. These parameters have not been extracted, the default values are shown.



List of components (see Fig.19)

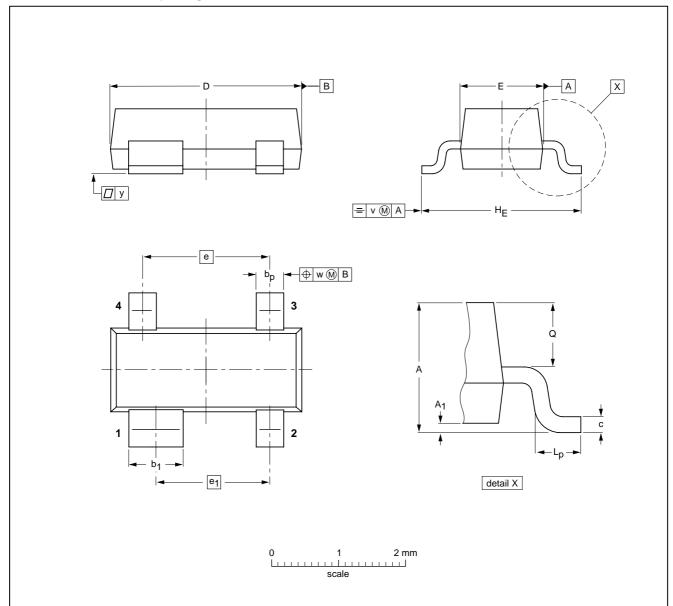
DESIGNATION	VALUE	UNIT
C _{be}	84	fF
C _{cb}	17	fF
C _{ce}	191	fF
L1	0.12	nH
L2	0.21	nH
L3	0.06	nH
L _B	0.95	nH
L _E	0.40	nH

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PACKAGE OUTLINES

Plastic surface mounted package; 4 leads

SOT143B



DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁ max	bp	b ₁	С	D	E	е	e ₁	HE	L _p	Q	v	w	у
mm	1.1 0.9	0.1	0.48 0.38	0.88 0.78	0.15 0.09	3.0 2.8	1.4 1.2	1.9	1.7	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1	0.1

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT143B					97-02-28	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFG92AX_N_6	20080312	Product data sheet	-	BFG92AX_N_5
Modifications:	 Characteristi 	cs Table; DC current gain value	e changed	
BFG92AX_N_5	20071126	Product data sheet	-	BFG92AX_4
BFG92AX_4 (9397 750 04344)	19980923	Product specification	-	BFG92SERIES_3
BFG92SERIES_3	19950912	Product specification	-	BFG92SERIES_2
BFG92SERIES_2	19921101	Product specification	-	BFG92_SERIES_1
BFG92_SERIES_1	-	-	-	-

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